

PIN DIODE**UM9701****Low Resistance, Low Distortion,
RF Switching Diode****Features**

- Low Forward Resistance
- High Reverse Resistance
- Specified Low Distortion
- High Voltage Capability
- Good Power Handling
- Microsemi Ruggedness and Reliability

Description

The UM9701 PIN diode was designed for low resistance at low forward bias current and low reverse bias capacitance. This unique Microsemi design results in both forward and reverse bias.

These PIN diodes are characterized for low current drain RF and microwave switch applications particularly for digital filter switch designs. The construction and geometry of these devices provide good voltage and power handling capability.

These devices are constructed using a metallurgical full face bond to both surfaces of the silicon chip. A glass enclosure houses this bond in a reliable and hermetic package. The axial leads are attached to the refractory pins and do not touch the glass enclosure.

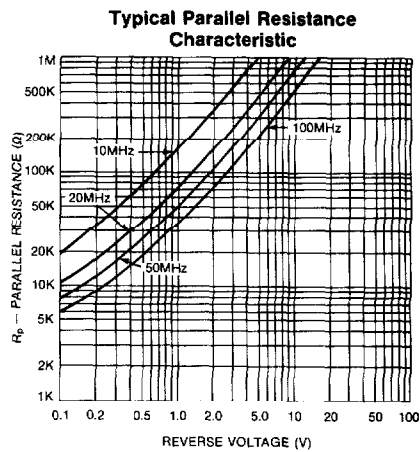
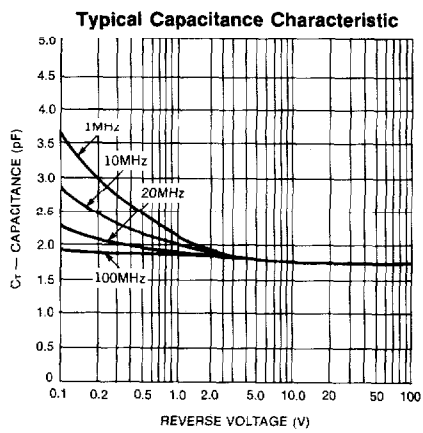
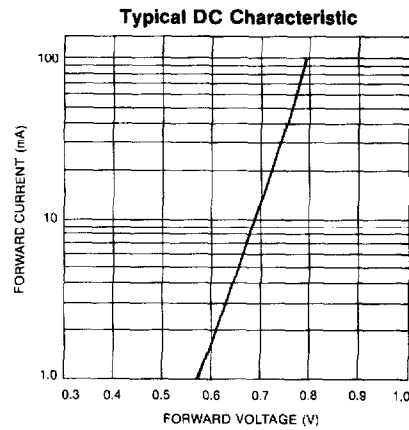
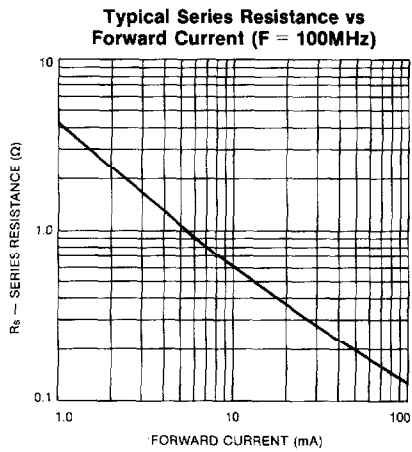
Environmentally these, and all Microsemi PIN diodes, can withstand thermal cycling from -195°C to +300°C and exceed all military environmental specifications for shock, vibration, acceleration and moisture resistance.

6**Maximum Ratings**

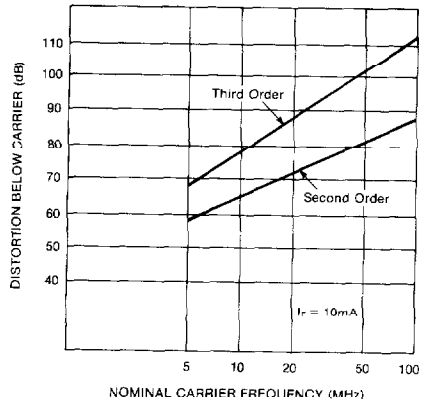
Reverse Voltage	100V
Average Power Dissipation Free Air at 25°C	500mW (Derate linearly to 175°C)
Average Power Dissipation ½" (12.7 mm) Total Lead Length to 25°C Contacts	2.5W (Derate linearly to 175°C)
Operating and Storage Temperature	-65°C to +175°C

Electrical Specifications

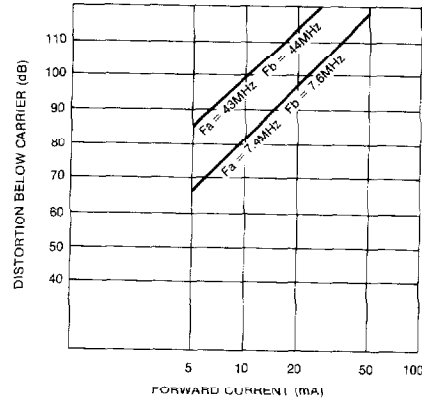
Test	Symbol	UM9701	Condition
Series Resistance (MAX)	R_s	0.8Ω	$f = 100\text{MHz}$, $I = 10\text{mA}$
Total Capacitance (MAX)	C_T	1.8pF	$f = 1\text{MHz}$, $V = 50\text{V}$
Parallel Resistance (MIN)	R_P	100kΩ	$f = 100\text{MHz}$, $V = 50\text{V}$
Carrier Lifetime (MIN)	τ	1.5μs	$I = 10\text{mA}$
Reverse Current (MAX)	I_R	10μA	$V = 100\text{V}$
Forward Voltage (MAX)	V_F	0.8V	$I = 10\text{mA}$
Forward Bias Third Order IM Distortion (MAX)	$R \frac{2ab}{a}$	-90dB	$I = 10\text{mA}$ $P_a = P_b = +20\text{dBm}$ $f_a = 43\text{MHz}$, $f_b = 44\text{MHz}$
Reverse Bias Third Order IM Distortion (MAX)	$R \frac{2ah}{a}$	-90dB	$V = 50\text{V}$ $P_a = P_b = +20\text{dBm}$ $f_a = 43\text{MHz}$, $f_b = 44\text{MHz}$



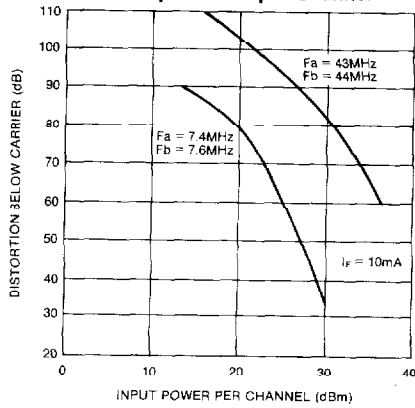
**Typical Forward Bias
Intermodulation Distortion
vs Nominal Carrier Frequency
at 20dBm per Channel**



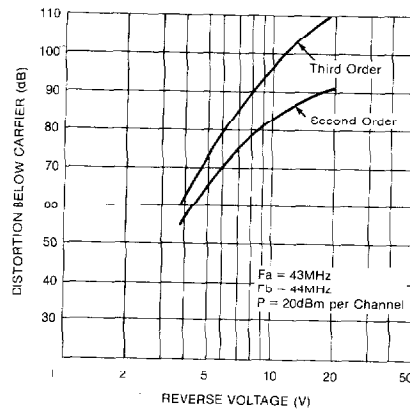
**Typical Third Order
Intermodulation Distortion ($R \frac{2ab}{a}$)
vs Forward Bias Current
at 20dBm per Channel**

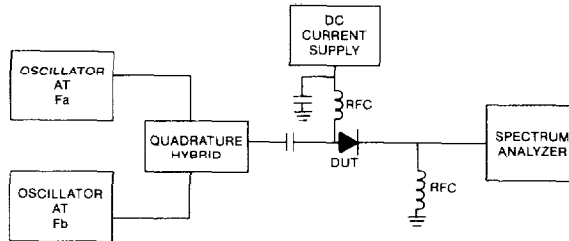
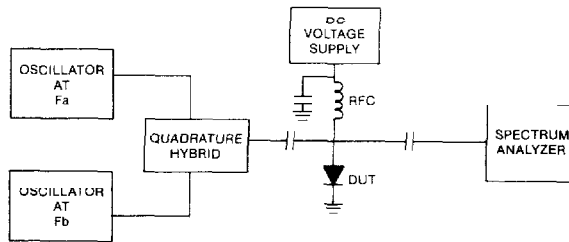


**Typical Forward Bias
Third Order
Intermodulation Distortion ($R \frac{2ab}{a}$)
vs Input Power per Channel**



**Typical Reverse Bias
Intermodulation Distortion**



Forward Bias Distortion Test Set**Reverse Bias Distortion Test Set****Mechanical Specifications**